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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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In re the application of: Miller *et al.*

Docket: TI-31007

Application No.: 09/886,781

Examiner: Jolley, Kirsten

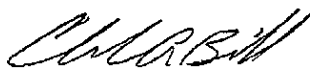
Filed: 21 June 2001

Art Unit: 1762

For: RE-COATING MEMS DEVICES USING DISSOLVED RESINS

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FACSIMILE COVER SHEET

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<input type="checkbox"/> CONTINUATION APP'N (# Pages)	
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NAME OF INVENTOR(S): Miller <i>et al.</i>	
TITLE OF INVENTION: Re-Coating MEMS Devices Using Dissolved Solids	
TI FILE NO.: TI-31007	DEPOSIT ACCT. NO.: 20-0668
FAXED: 01/15/2004 DUE: 1/15/2004 ATTY/SECY: CAB:ss	
RECEIPT DATE & SERIAL NO.: Application No.: 09/886,781 Filing Date: 07/21/2001	

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Texas Instruments Incorporated  
PO Box 655474, M/S 3999  
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JAN 15 2004  
OFFICIALResponse under 37 C.F.R. 1.116  
Expedited Procedure  
Examining Group (1762)

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Miller et al.

Art Unit: 1762

Serial No.: 09/886,781

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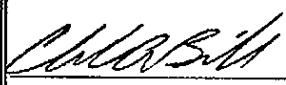
Docket No. TI-31007

For: RE-COATING MEMS DEVICES USING DISSOLVED RESINS

## AMENDMENT UNDER 37 C.F.R. 1.116

15 January 2004

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Dear Sir:

In response to the Examiner's Action mailed 15 October 2003, applicant amends as follows: